Vishay Semiconductors

RoHS

COMPLIANT

HALOGEN

Thyristor Surface Mount, Phase Control SCR, 8 A



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PRIMARY CHARACTERISTICS			
I _{T(AV)}	8 A		
V _{DRM} /V _{RRM}	800 V		
V _{TM}	1.2 V		
I _{GT}	15 mA		
TJ	-40 to +125 °C		
Package	D ² PAK (TO-263AB)		
Circuit configuration	Single SCR		

FEATURES

- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- \bullet Designed and qualified according JEDEC $^{\textcircled{B}}\mbox{-}JESD$ 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Input rectification and crow-bar (soft start)
- Vishay input diodes, switches and output rectifiers which are available in identical package outlines

DESCRIPTION

The VS-12TTS08S-M3 High Voltage Series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS						
APPLICATIONS	SINGLE-PHASE BRIDGE	THREE-PHASE BRIDGE	UNITS			
Capacitive input filter $T_A = 55$ °C, $T_J = 125$ °C, common heatsink of 1 °C/W	13.5	17	А			

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
I _{T(AV)}	Sinusoidal waveform	8	۸			
I _{T(RMS)}		12.5	A			
V _{RRM} /V _{DRM}		800	V			
I _{TSM}		110	A			
V _T	8 A, T _J = 25 °C	1.2	V			
dV/dt		150	V/µs			
dl/dt		100	A/µs			
TJ	Range	-40 to +125	°C			

VOLTAGE RATINGS							
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM PEAK DIRECT VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA				
VS-12TTS08S-M3	800	800	1.0				

VS-12TTS08S-M3 Series



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ABSOLUTE MAXIMUM RATINGS	;			
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average on-state current	I _{T(AV)}		8	
Maximum RMS on-state current	I _{T(RMS)}	$T_{C} = 108 \text{ °C}, 180^{\circ} \text{ conduction, half sine wave}$	12.5	•
Maximum peak one-cycle		10 ms sine pulse, rated V_{RRM} applied, T_J = 125 °C	95	A
non-repetitive surge current	ITSM	10 ms sine pulse, no voltage reapplied, $T_J = 125 \text{ °C}$	110	
Movimum 1 ² t for fusing	l ² t	10 ms sine pulse, rated V_{RRM} applied, T_J = 125 °C	45	A ² s
Maximum I ² t for fusing	I-t	10 ms sine pulse, no voltage reapplied, $T_J = 125 \ ^\circ C$	64	
Maximum I ² √t for fusing	l²√t	t = 0.1 ms to 10 ms, no voltage reapplied, T_J = 125 °C	640	A²√s
Maximum on-state voltage drop	V _{TM}	8 A, T _J = 25 °C	1.2	V
On-state slope resistance	r _t	Т. _I = 125 °С	16.2	mΩ
Threshold voltage	V _{T(TO)}	IJ = 123 C	0.87	V
Maximum reverse and direct leakage current	1 /1	$T_J = 25 ^{\circ}C$	0.05	
Maximum reverse and direct leakage current	I _{RM} /I _{DM}	$T_J = 125 \text{ °C}$ $V_R = \text{Rated } V_{RRM}/V_{DRM}$	1.0	
Typical holding current	Ι _Η	Anode supply = 6 V, resistive load, initial I_T = 1 A, T_J = 25 °C	30	mA
Maximum latching current	١L	Anode supply = 6 V, resistive load, $T_J = 25 \ ^{\circ}C$	50	
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J max.$, linear to 80 %, $V_{DRM} = R_g - k = Open$	150	V/µs
Maximum rate of rise of turned-on current	dl/dt		100	A/µs

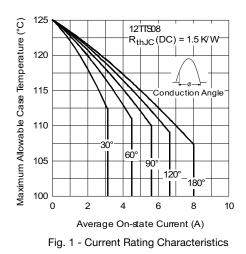
TRIGGERING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum peak gate power	P _{GM}		8.0	۱۸/	
Maximum average gate power	P _{G(AV)}		2.0	W	
Maximum peak positive gate current	+ I _{GM}		1.5	А	
Maximum peak negative gate voltage	- V _{GM}		10	V	
	I _{GT}	Anode supply = 6 V, resistive load, T_J = - 65 °C	20	mA	
Maximum required DC gate current to trigger		Anode supply = 6 V, resistive load, $T_J = 25 \text{ °C}$	15		
		Anode supply = 6 V, resistive load, $T_J = 125 \text{ °C}$	10		
		Anode supply = 6 V, resistive load, $T_J = -65 \text{ °C}$	1.2		
Maximum required DC gate voltage to trigger	V _{GT}	Anode supply = 6 V, resistive load, $T_J = 25 \text{ °C}$	1	V	
		Anode supply = 6 V, resistive load, $T_J = 125 \text{ °C}$	0.7	v	
Maximum DC gate voltage not to trigger	V _{GD}	T = 125 % $V = -$ Botod value	0.2		
Maximum DC gate current not to trigger	I _{GD}	T _J = 125 °C, V _{DRM} = Rated value	0.1	mA	

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Typical turn-on time	t _{gt}	T _J = 25 °C	0.8	
Typical reverse recovery time	t _{rr}	T _{.1} = 125 °C	3	μs
Typical turn-off time	t _q	1) = 125 0	100	



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THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and sto temperature range	orage	T _J , T _{Stg}		-40 to +125	°C
Maximum thermal resistar junction to case	nce,	R _{thJC}	DC operation	1.5	
Maximum thermal resistance, junction to ambient		R _{thJA}		62	°C/W
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.5	
Approvimate weight				2	g
Approximate weight				0.07	oz.
Mounting torgue –	minimum			6 (5)	kgf ⋅ cm
Mounting torque	maximum			12 (10)	(lbf · in)
Marking device			Case style D ² PAK (TO-263AB)	12TT	S08S



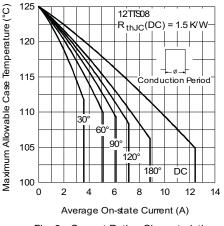


Fig. 2 - Current Rating Characteristics

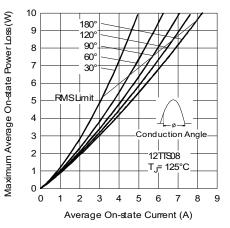


Fig. 3 - On-State Power Loss Characteristics

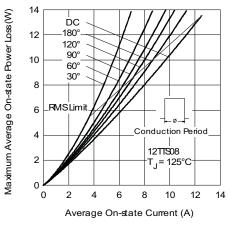


Fig. 4 - On-State Power Loss Characteristics

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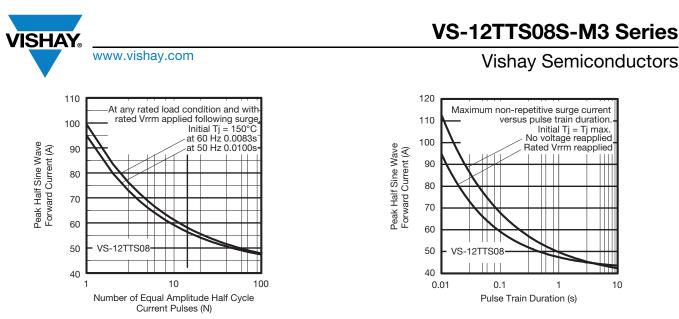
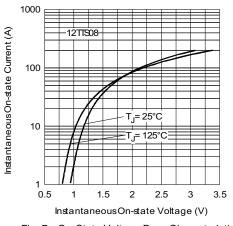


Fig. 5 - Maximum Non-Repetitive Surge Current

Fig. 6 - Maximum Non-Repetitive Surge Current





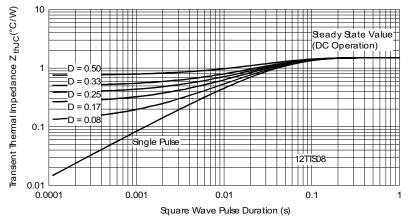


Fig. 8 - Thermal Impedance ZthJC Characteristics

VS-12TTS08S-M3 Series

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ORDERING INFORMATION TABLE

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Device code	VS-	12	т	т	S	08	S	TRL	-M3
		2	3	4	5	6	7	8	9
	1	- Visl	hay Sen	nicondu	ctors pro	oduct			
	2 ·	- Cur	rent rati	ng (12.5	5 A)				
	3 -	- Circ	cuit conf	iguratio	n:				
		T =	single t	hyristor					
	4	- Pac	kage:						
	_	T =	D ² PAK	(TO-263	BAB)				
	5 -	- Тур	e of silio	con:					
		S =	standa	rd recov	ery rect	ifier			
	6	- Vol	tage rati	ing (08 =	= 800 V))			
	7 -	S =	surface	mounta	able				
	8 -	• No	one = tu	be					
		• TF	RL = tap	e and re	el (left o	oriented)		
		• TF	R = tap	be and r	eel (righ	t oriente	ed)		
	9 -		-	gen-free			-	termina	ations le

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-12TTS08S-M3	50	1000	Antistatic plastic tubes				
VS-12TTS08STRR-M3	800	800	13" diameter reel				
VS-12TTS08STRL-M3	800	800	13" diameter reel				

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?96164			
Part marking information	www.vishay.com/doc?95444			
Packaging information	www.vishay.com/doc?96424			

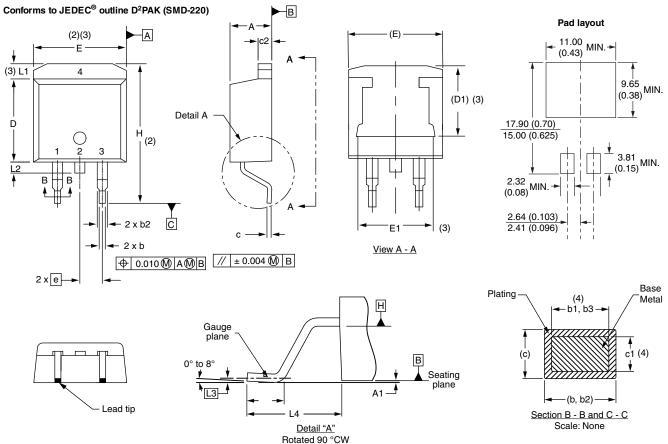
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D²PAK

DIMENSIONS in millimeters and inches

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lotated	90) °C\
<u>Scal</u>	<u>e:</u> 8	3:1

SYMBOL	MILLIMETERS		INCHES		NOTES
STWBUL	MIN.	MAX.	MIN.	MAX.	NOTES
A	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010 BSC		
L4	4.78	5.28	0.188	0.208	

Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5 M-1994

(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

⁽³⁾ Thermal pad contour optional within dimension E, L1, D1 and E1

⁽⁴⁾ Dimension b1 and c1 apply to base metal only

⁽⁵⁾ Datum A and B to be determined at datum plane H

⁽⁶⁾ Controlling dimension: inches

⁽⁷⁾ Outline conforms to JEDEC[®] outline TO-263AB

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